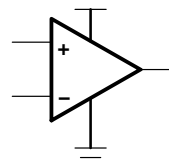


# TLV271-Q1, TLV272-Q1, TLV274-Q1 FAMILY OF 550- $\mu$ A/Ch 3-MHz RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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- Qualified for Automotive Applications
- Rail-To-Rail Output
- Wide Bandwidth . . . 3 MHz
- High Slew Rate . . . 2.4 V/ $\mu$ s
- Supply Voltage Range . . . 2.7 V to 16 V
- Supply Current . . . 550  $\mu$ A/Channel
- Input Noise Voltage . . . 39 nV/ $\sqrt{\text{Hz}}$
- Input Bias Current . . . 1 pA
- Specified Temperature Range  
–40°C to 125°C . . . Automotive Grade
- Ultrasmall Packaging  
– 5-Pin SOT-23 (TLV271)
- Ideal Upgrade for TLC27x Family

Operational Amplifier



## description

The TLV27x takes the minimum operating supply voltage down to 2.7 V over the extended automotive temperature range while adding the rail-to-rail output swing feature. This makes it an ideal alternative to the TLC27x family for applications where rail-to-rail output swings are essential. The TLV27x also provides 3-MHz bandwidth from only 550  $\mu$ A.

Like the TLC27x, the TLV27x is fully specified for 5-V and  $\pm$ 5-V supplies. The maximum recommended supply voltage is 16 V, which allows the devices to be operated from a variety of rechargeable cells ( $\pm$ 8 V supplies down to  $\pm$ 1.35 V).

The CMOS inputs enable use in high-impedance sensor interfaces, with the lower voltage operation making an attractive alternative for the TLC27x in battery-powered applications.

The 2.7-V operation makes it compatible with Li-Ion powered systems and the operating supply voltage range of many micropower microcontrollers available today including Texas Instruments MSP430.

SELECTION OF SIGNAL AMPLIFIER PRODUCTS†

| DEVICE  | V <sub>DD</sub> (V) | V <sub>IO</sub> ( $\mu$ V) | I <sub>q</sub> /Ch ( $\mu$ A) | I <sub>IB</sub> (pA) | GBW (MHz) | SR (V/ $\mu$ s) | SHUTDOWN | RAIL-TO-RAIL | SINGLES/DUALS/QUADS |
|---------|---------------------|----------------------------|-------------------------------|----------------------|-----------|-----------------|----------|--------------|---------------------|
| TLV27x  | 2.7–16              | 500                        | 550                           | 1                    | 3         | 2.4             | —        | O            | S/D/Q               |
| TLC27x  | 3–16                | 1100                       | 675                           | 1                    | 1.7       | 3.6             | —        | —            | S/D/Q               |
| TLV237x | 2.7–16              | 500                        | 550                           | 1                    | 3         | 2.4             | Yes      | I/O          | S/D/Q               |
| TLC227x | 4–16                | 300                        | 1100                          | 1                    | 2.2       | 3.6             | —        | O            | D/Q                 |
| TLV246x | 2.7–6               | 150                        | 550                           | 1300                 | 6.4       | 1.6             | Yes      | I/O          | S/D/Q               |
| TLV247x | 2.7–6               | 250                        | 600                           | 2                    | 2.8       | 1.5             | Yes      | I/O          | S/D/Q               |
| TLV244x | 2.7–10              | 300                        | 725                           | 1                    | 1.8       | 1.4             | —        | O            | D/Q                 |

† Typical values measured at 5 V, 25°C



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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# TLV271-Q1, TLV272-Q1, TLV274-Q1

## FAMILY OF 550- $\mu$ A/Ch 3-MHz RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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FAMILY PACKAGE TABLE<sup>†</sup>

| DEVICE | NUMBER OF CHANNELS | PACKAGE TYPES <sup>‡</sup> |        |       |                   | UNIVERSAL EVM BOARD                   |
|--------|--------------------|----------------------------|--------|-------|-------------------|---------------------------------------|
|        |                    | SOIC                       | SOT-23 | TSSOP | MSOP <sup>§</sup> |                                       |
| TLV271 | 1                  | 8                          | 5      | —     | —                 | See the EVM Selection Guide (SLOU060) |
| TLV272 | 2                  | 8                          | —      | —     | 8                 |                                       |
| TLV274 | 4                  | 14                         | —      | 14    | —                 |                                       |

<sup>†</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at <http://www.ti.com>.

<sup>‡</sup> Package drawings, thermal data, and symbolization are available at <http://www.ti.com/packaging>.

<sup>§</sup> Product Preview

TLV271 AVAILABLE OPTIONS

| T <sub>A</sub> | V <sub>IO</sub> MAX AT 25°C | PACKAGED DEVICES  |               |        |
|----------------|-----------------------------|-------------------|---------------|--------|
|                |                             | SMALL OUTLINE (D) | SOT-23        |        |
|                |                             |                   | (DBV)         | SYMBOL |
| –40°C to 125°C | 5 mV                        | TLV271QDRQ1       | TLV271QDBVRQ1 | 271Q   |

TLV272 AVAILABLE OPTIONS

| T <sub>A</sub> | V <sub>IO</sub> MAX AT 25°C | PACKAGED DEVICES  |                            |        |
|----------------|-----------------------------|-------------------|----------------------------|--------|
|                |                             | SMALL OUTLINE (D) | MSOP                       |        |
|                |                             |                   | (DGK)                      | SYMBOL |
| –40°C to 125°C | 5 mV                        | TLV272QDRQ1       | TLV272QDGKRQ1 <sup>†</sup> |        |

<sup>†</sup> Product Preview

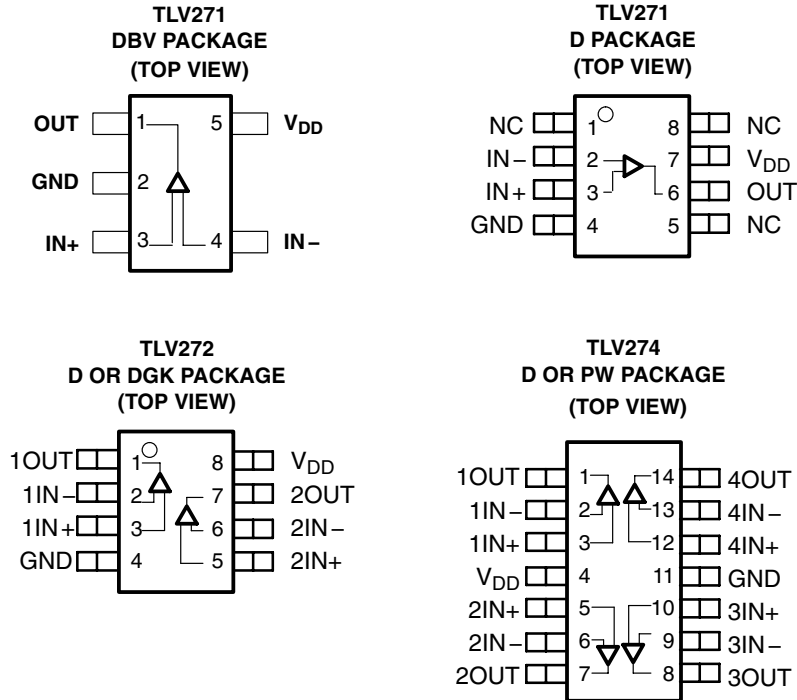
TLV274 AVAILABLE OPTIONS

| T <sub>A</sub> | V <sub>IO</sub> MAX AT 25°C | PACKAGED DEVICES  |              |
|----------------|-----------------------------|-------------------|--------------|
|                |                             | SMALL OUTLINE (D) | TSSOP (PW)   |
| –40°C to 125°C | 5 mV                        | TLV274QDRQ1       | TLV274QPWRQ1 |

# TLV271-Q1, TLV272-Q1, TLV274-Q1 FAMILY OF 550- $\mu$ A/Ch 3-MHz RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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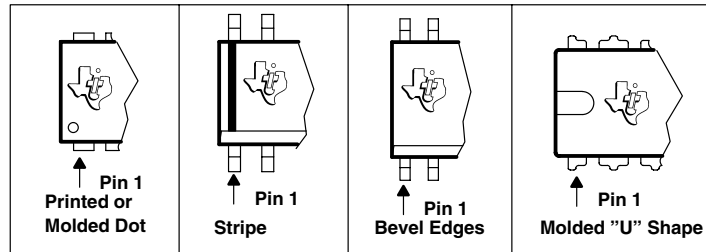
## TLV27x PACKAGE PINOUTS<sup>(1)</sup>



NC – No internal connection

(1) SOT-23 may or may not be indicated

## TYPICAL PIN 1 INDICATORS



# TLV271-Q1, TLV272-Q1, TLV274-Q1

## FAMILY OF 550- $\mu$ A/Ch 3-MHz RAIL-TO-RAIL OUTPUT

### OPERATIONAL AMPLIFIERS

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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|                                                              |                              |
|--------------------------------------------------------------|------------------------------|
| Supply voltage, $V_{DD}$ (see Note 1)                        | 16.5 V                       |
| Differential input voltage, $V_{ID}$                         | $\pm V_{DD}$                 |
| Input voltage range, $V_I$ (see Note 1)                      | -0.2 V to $V_{DD} + 0.2$ V   |
| Input current range, $I_I$                                   | $\pm 10$ mA                  |
| Output current range, $I_O$                                  | $\pm 100$ mA                 |
| Continuous total power dissipation                           | See Dissipation Rating Table |
| Operating free-air temperature range, $T_A$                  | -40°C to 125°C               |
| Maximum junction temperature, $T_J$                          | 150°C                        |
| Storage temperature range, $T_{stg}$                         | -65°C to 150°C               |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | 260°C                        |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values, except differential voltages, are with respect to GND.

DISSIPATION RATING TABLE

| PACKAGE | $\theta_{JC}$<br>(°C/W) | $\theta_{JA}$<br>(°C/W) | $T_A \leq 25^\circ\text{C}$<br>POWER RATING | $T_A = 25^\circ\text{C}$<br>POWER RATING |
|---------|-------------------------|-------------------------|---------------------------------------------|------------------------------------------|
| D (8)   | 38.3                    | 176                     | 710 mW                                      | 396 mW                                   |
| D (14)  | 26.9                    | 122.3                   | 1022 mW                                     | 531 mW                                   |
| DBV (5) | 55                      | 324.1                   | 385 mW                                      | 201 mW                                   |
| DGK (8) | 54.23                   | 259.96                  | 481 mW                                      | 250 mW                                   |
| PW (14) | 29.3                    | 173.6                   | 720 mW                                      | 374 mW                                   |

#### recommended operating conditions

|                                            |               | MIN        | MAX             | UNIT |
|--------------------------------------------|---------------|------------|-----------------|------|
| Supply voltage, $V_{DD}$                   | Single supply | 2.7        | 16              | V    |
|                                            | Split supply  | $\pm 1.35$ | $\pm 8$         |      |
| Common-mode input voltage range, $V_{ICR}$ |               | 0          | $V_{DD} - 1.35$ | V    |
| Operating free-air temperature, $T_A$      | Q-suffix      | -40        | 125             | °C   |



**TLV271-Q1, TLV272-Q1, TLV274-Q1**  
**FAMILY OF 550- $\mu$ A/Ch 3-MHz RAIL-TO-RAIL OUTPUT**  
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electrical characteristics at specified free-air temperature,  $V_{DD} = 2.7\text{ V}$ ,  $5\text{ V}$ , and  $15\text{ V}$  (unless otherwise noted)

**dc performance**

| PARAMETER                                                | TEST CONDITIONS                                                                                        | $T_A^\dagger$           | MIN        | TYP | MAX | UNIT                         |
|----------------------------------------------------------|--------------------------------------------------------------------------------------------------------|-------------------------|------------|-----|-----|------------------------------|
| $V_{IO}$ Input offset voltage                            | $V_{IC} = V_{DD}/2$ ,<br>$R_L = 10\text{ k}\Omega$ ,<br>$V_O = V_{DD}/2$ ,<br>$R_S = 50\text{ }\Omega$ | 25°C                    |            | 0.5 | 5   | mV                           |
|                                                          |                                                                                                        | Full range              |            |     | 7   |                              |
| $\alpha_{VIO}$ Offset voltage drift                      |                                                                                                        | 25°C                    |            | 2   |     | $\mu\text{V}/^\circ\text{C}$ |
| $CMRR$ Common-mode rejection ratio                       | $V_{IC} = 0\text{ to }V_{DD}-1.35\text{ V}$ ,<br>$R_S = 50\text{ }\Omega$                              | $V_{DD} = 2.7\text{ V}$ | 25°C       | 53  | 70  | dB                           |
|                                                          |                                                                                                        |                         | Full range | 54  |     |                              |
|                                                          | $V_{IC} = 0\text{ to }V_{DD}-1.35\text{ V}$ ,<br>$R_S = 50\text{ }\Omega$                              | $V_{DD} = 5\text{ V}$   | 25°C       | 58  | 80  |                              |
|                                                          |                                                                                                        |                         | Full range | 57  |     |                              |
|                                                          | $V_{IC} = 0\text{ to }V_{DD}-1.35\text{ V}$ ,<br>$R_S = 50\text{ }\Omega$                              | $V_{DD} = 15\text{ V}$  | 25°C       | 67  | 85  |                              |
|                                                          |                                                                                                        |                         | Full range | 66  |     |                              |
| $A_{VD}$ Large-signal differential voltage amplification | $V_{O(PP)} = V_{DD}/2$ ,<br>$R_L = 10\text{ k}\Omega$                                                  | $V_{DD} = 2.7\text{ V}$ | 25°C       | 95  | 106 | dB                           |
|                                                          |                                                                                                        |                         | Full range | 76  |     |                              |
|                                                          |                                                                                                        | $V_{DD} = 5\text{ V}$   | 25°C       | 80  | 110 |                              |
|                                                          |                                                                                                        |                         | Full range | 82  |     |                              |
|                                                          |                                                                                                        | $V_{DD} = 15\text{ V}$  | 25°C       | 77  | 115 |                              |
|                                                          |                                                                                                        |                         | Full range | 79  |     |                              |

$^\dagger$  Full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ . If not specified, full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

**input characteristics**

| PARAMETER         |                               | TEST CONDITIONS                                                                                                                | T <sub>A</sub> | MIN | TYP  | MAX  | UNIT |
|-------------------|-------------------------------|--------------------------------------------------------------------------------------------------------------------------------|----------------|-----|------|------|------|
| I <sub>IO</sub>   | Input offset current          | V <sub>DD</sub> = 15 V,    V <sub>IC</sub> = V <sub>DD</sub> /2,<br>V <sub>O</sub> = V <sub>DD</sub> /2, R <sub>S</sub> = 50 Ω | 25°C           |     | 1    | 60   | pA   |
|                   |                               |                                                                                                                                | 125°C          |     |      | 1000 |      |
| I <sub>IB</sub>   | Input bias current            |                                                                                                                                | 25°C           |     | 1    | 60   | pA   |
|                   |                               |                                                                                                                                | 125°C          |     |      | 1000 |      |
| r <sub>i(d)</sub> | Differential input resistance |                                                                                                                                | 25°C           |     | 1000 |      | GΩ   |
| C <sub>IC</sub>   | Common-mode input capacitance | f = 21 kHz                                                                                                                     | 25°C           |     | 8    |      | pF   |



# TLV271-Q1, TLV272-Q1, TLV274-Q1

## FAMILY OF 550- $\mu$ A/Ch 3-MHz RAIL-TO-RAIL OUTPUT

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electrical characteristics at specified free-air temperature,  $V_{DD} = 2.7$  V, 5 V, and 15 V (unless otherwise noted)

#### output characteristics

| PARAMETER                          | TEST CONDITIONS                           |                  | $T_A^\dagger$ | MIN   | TYP   | MAX  | UNIT |
|------------------------------------|-------------------------------------------|------------------|---------------|-------|-------|------|------|
| $V_{OH}$ High-level output voltage | $V_{IC} = V_{DD}/2, I_{OH} = -1$ mA       | $V_{DD} = 2.7$ V | 25°C          | 2.55  | 2.58  |      | V    |
|                                    |                                           |                  | Full range    | 2.48  |       |      |      |
|                                    |                                           | $V_{DD} = 5$ V   | 25°C          | 4.9   | 4.93  |      |      |
|                                    |                                           |                  | Full range    | 4.85  |       |      |      |
|                                    |                                           | $V_{DD} = 15$ V  | 25°C          | 14.92 | 14.96 |      |      |
|                                    |                                           |                  | Full range    | 14.9  |       |      |      |
|                                    | $V_{IC} = V_{DD}/2, I_{OH} = -5$ mA       | $V_{DD} = 2.7$ V | 25°C          | 1.88  | 2.1   |      |      |
|                                    |                                           |                  | Full range    | 1.42  |       |      |      |
|                                    |                                           | $V_{DD} = 5$ V   | 25°C          | 4.58  | 4.68  |      |      |
|                                    |                                           |                  | Full range    | 4.44  |       |      |      |
|                                    |                                           | $V_{DD} = 15$ V  | 25°C          | 14.7  | 14.8  |      |      |
|                                    |                                           |                  | Full range    | 14.6  |       |      |      |
| $V_{OL}$ Low-level output voltage  | $V_{IC} = V_{DD}/2, I_{OL} = 1$ mA        | $V_{DD} = 2.7$ V | 25°C          |       | 0.1   | 0.15 | V    |
|                                    |                                           |                  | Full range    |       |       | 0.22 |      |
|                                    |                                           | $V_{DD} = 5$ V   | 25°C          |       | 0.05  | 0.1  |      |
|                                    |                                           |                  | Full range    |       |       | 0.15 |      |
|                                    |                                           | $V_{DD} = 15$ V  | 25°C          |       | 0.05  | 0.08 |      |
|                                    |                                           |                  | Full range    |       |       | 0.1  |      |
|                                    | $V_{IC} = V_{DD}/2, I_{OL} = 5$ mA        | $V_{DD} = 2.7$ V | 25°C          |       | 0.5   | 0.7  |      |
|                                    |                                           |                  | Full range    |       |       | 1.15 |      |
|                                    |                                           | $V_{DD} = 5$ V   | 25°C          |       | 0.28  | 0.4  |      |
|                                    |                                           |                  | Full range    |       |       | 0.54 |      |
|                                    |                                           | $V_{DD} = 15$ V  | 25°C          |       | 0.19  | 0.3  |      |
|                                    |                                           |                  | Full range    |       |       | 0.35 |      |
| $I_O$ Output current               | $V_O = 0.5$ V from rail, $V_{DD} = 2.7$ V | Positive rail    | 25°C          |       | 4     |      | mA   |
|                                    |                                           | Negative rail    | 25°C          |       | 5     |      |      |
|                                    | $V_O = 0.5$ V from rail, $V_{DD} = 5$ V   | Positive rail    | 25°C          |       | 7     |      |      |
|                                    |                                           | Negative rail    | 25°C          |       | 8     |      |      |
|                                    | $V_O = 0.5$ V from rail, $V_{DD} = 15$ V  | Positive rail    | 25°C          |       | 13    |      |      |
|                                    |                                           | Negative rail    | 25°C          |       | 12    |      |      |

$^\dagger$  Full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ . If not specified, full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

$^\ddagger$  Depending on package dissipation rating

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**electrical characteristics at specified free-air temperature,  $V_{DD} = 2.7$  V, 5 V, and 15 V (unless otherwise noted) (continued)**

**power supply**

| PARAMETER                                                             | TEST CONDITIONS                                         | $T_A^\dagger$    | MIN  | TYP | MAX  | UNIT    |
|-----------------------------------------------------------------------|---------------------------------------------------------|------------------|------|-----|------|---------|
| $I_{DD}$ Supply current (per channel)                                 | $V_O = V_{DD}/2$                                        | $V_{DD} = 2.7$ V | 25°C | 470 | 560  | $\mu$ A |
|                                                                       |                                                         | $V_{DD} = 5$ V   | 25°C | 550 | 660  |         |
|                                                                       |                                                         | $V_{DD} = 15$ V  | 25°C | 750 | 900  |         |
|                                                                       |                                                         | Full range       |      |     | 1200 |         |
| PSRR Supply voltage rejection ratio ( $\Delta V_{DD}/\Delta V_{IO}$ ) | $V_{DD} = 2.7$ V to 15 V, $V_{IC} = V_{DD}/2$ , No load | 25°C             | 70   | 80  |      | dB      |
|                                                                       |                                                         | Full range       | 65   |     |      |         |

$^\dagger$  Full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ . If not specified, full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

**dynamic performance**

| PARAMETER                  | TEST CONDITIONS                                                                              | $T_A^\dagger$          | MIN  | TYP | MAX | UNIT       |
|----------------------------|----------------------------------------------------------------------------------------------|------------------------|------|-----|-----|------------|
| UGBW Unity gain bandwidth  | $R_L = 2$ k $\Omega$ , $C_L = 10$ pF                                                         | $V_{DD} = 2.7$ V       | 25°C | 2.4 |     | MHz        |
|                            |                                                                                              | $V_{DD} = 5$ V to 15 V | 25°C | 3   |     |            |
| SR Slew rate at unity gain | $V_{O(PP)} = V_{DD}/2$ , $C_L = 50$ pF, $R_L = 10$ k $\Omega$ ,                              | $V_{DD} = 2.7$ V       | 25°C | 1.4 | 2.1 | V/ $\mu$ s |
|                            |                                                                                              | Full range             |      | 1   |     |            |
|                            |                                                                                              | $V_{DD} = 5$ V         | 25°C | 1.4 | 2.4 | V/ $\mu$ s |
|                            |                                                                                              | Full range             |      | 1.2 |     |            |
|                            |                                                                                              | $V_{DD} = 15$ V        | 25°C | 1.9 | 2.1 | V/ $\mu$ s |
|                            |                                                                                              | Full range             |      | 1.4 |     |            |
| $\phi_m$ Phase margin      | $R_L = 2$ k $\Omega$                                                                         | $C_L = 10$ pF          | 25°C | 65  |     | $^\circ$   |
| Gain margin                | $R_L = 2$ k $\Omega$                                                                         | $C_L = 10$ pF          | 25°C | 18  |     | dB         |
| $t_s$ Settling time        | $V_{DD} = 2.7$ V, $V_{(STEP)PP} = 1$ V, $A_V = -1$ , $C_L = 10$ pF, $R_L = 2$ k $\Omega$     | 0.1%                   | 25°C | 2.9 |     | $\mu$ s    |
|                            | $V_{DD} = 5$ V, 15 V, $V_{(STEP)PP} = 1$ V, $A_V = -1$ , $C_L = 47$ pF, $R_L = 2$ k $\Omega$ | 0.1%                   |      | 2   |     |            |

$^\dagger$  Full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ . If not specified, full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

**noise/distortion performance**

| PARAMETER                                    | TEST CONDITIONS                                                                        | $T_A$       | MIN  | TYP   | MAX | UNIT                   |
|----------------------------------------------|----------------------------------------------------------------------------------------|-------------|------|-------|-----|------------------------|
| THD + N Total harmonic distortion plus noise | $V_{DD} = 2.7$ V, $V_{O(PP)} = V_{DD}/2$ V, $R_L = 2$ k $\Omega$ , $f = 10$ kHz        | $A_V = 1$   | 25°C | 0.02% |     |                        |
|                                              |                                                                                        | $A_V = 10$  |      | 0.05% |     |                        |
|                                              |                                                                                        | $A_V = 100$ |      | 0.18% |     |                        |
|                                              | $V_{DD} = 5$ V, $\pm 5$ V, $V_{O(PP)} = V_{DD}/2$ V, $R_L = 2$ k $\Omega$ , $f = 10$ K | $A_V = 1$   | 25°C | 0.02% |     |                        |
|                                              |                                                                                        | $A_V = 10$  |      | 0.09% |     |                        |
|                                              |                                                                                        | $A_V = 100$ |      | 0.5%  |     |                        |
| $V_n$ Equivalent input noise voltage         | $f = 1$ kHz                                                                            | 25°C        |      | 39    |     | nV/ $\sqrt{\text{Hz}}$ |
|                                              | $f = 10$ kHz                                                                           |             |      | 35    |     |                        |
| $I_n$ Equivalent input noise current         | $f = 1$ kHz                                                                            | 25°C        |      | 0.6   |     | fA/ $\sqrt{\text{Hz}}$ |



# TLV271-Q1, TLV272-Q1, TLV274-Q1

## FAMILY OF 550- $\mu$ A/Ch 3-MHz RAIL-TO-RAIL OUTPUT

### OPERATIONAL AMPLIFIERS

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#### TYPICAL CHARACTERISTICS

Table of Graphs

|             |                                              |                              | FIGURE  |
|-------------|----------------------------------------------|------------------------------|---------|
| CMRR        | Common-mode rejection ratio                  | vs Frequency                 | 1       |
|             | Input bias and offset current                | vs Free-air temperature      | 2       |
| $V_{OL}$    | Low-level output voltage                     | vs Low-level output current  | 3, 5, 7 |
| $V_{OH}$    | High-level output voltage                    | vs High-level output current | 4, 6, 8 |
| $V_{O(PP)}$ | Peak-to-peak output voltage                  | vs Frequency                 | 9       |
| $I_{DD}$    | Supply current                               | vs Supply voltage            | 10      |
| PSRR        | Power supply rejection ratio                 | vs Frequency                 | 11      |
| $A_{VD}$    | Differential voltage gain & phase            | vs Frequency                 | 12      |
|             | Gain-bandwidth product                       | vs Free-air temperature      | 13      |
| SR          | Slew rate                                    | vs Supply voltage            | 14      |
|             |                                              | vs Free-air temperature      | 15      |
| $\phi_m$    | Phase margin                                 | vs Capacitive load           | 16      |
| $V_n$       | Equivalent input noise voltage               | vs Frequency                 | 17      |
|             | Voltage-follower large-signal pulse response |                              | 18, 19  |
|             | Voltage-follower small-signal pulse response |                              | 20      |
|             | Inverting large-signal response              |                              | 21, 22  |
|             | Inverting small-signal response              |                              | 23      |
|             | Crosstalk                                    | vs Frequency                 | 24      |





# TLV271-Q1, TLV272-Q1, TLV274-Q1

## FAMILY OF 550- $\mu$ A/Ch 3-MHz RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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### TYPICAL CHARACTERISTICS

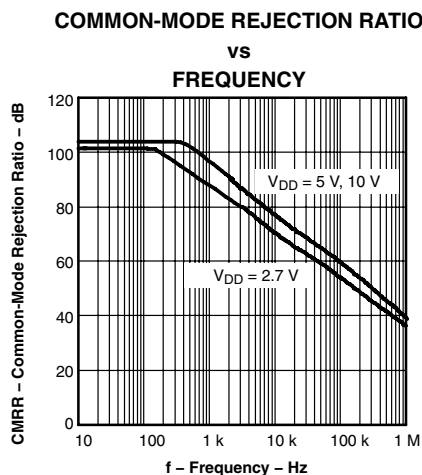


Figure 1

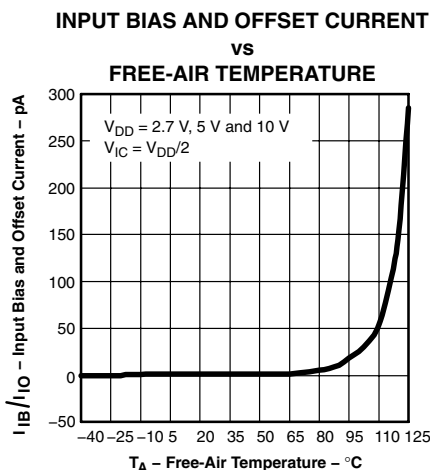


Figure 2

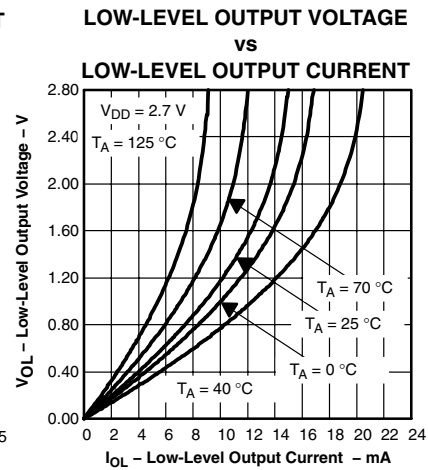


Figure 3

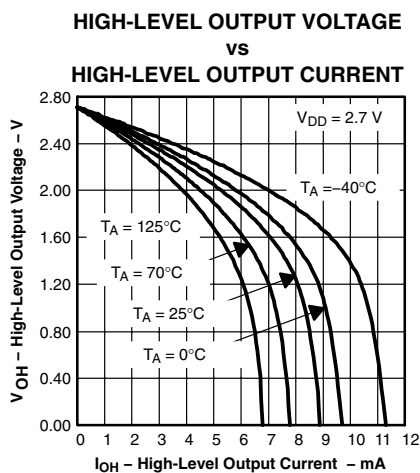


Figure 4

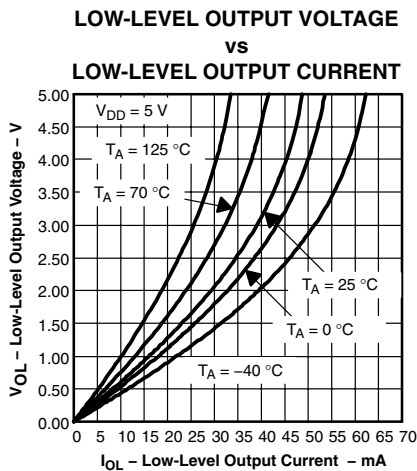


Figure 5

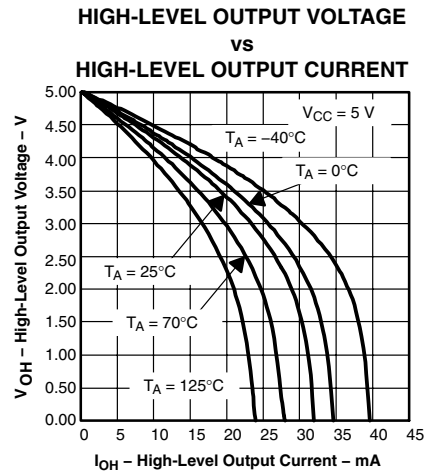


Figure 6

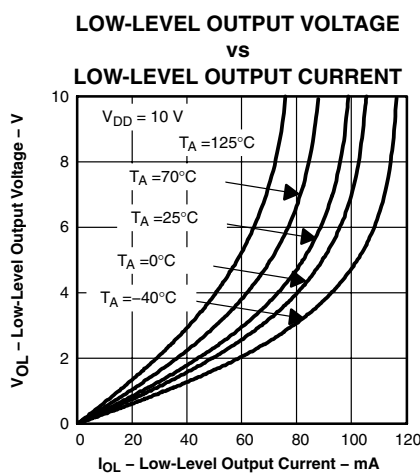


Figure 7

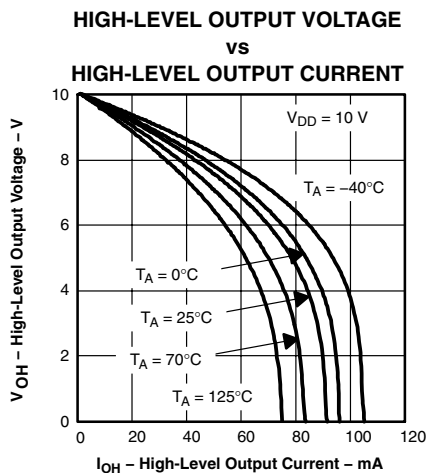


Figure 8

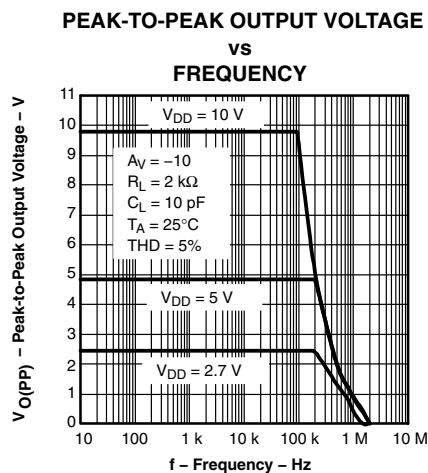


Figure 9

# TLV271-Q1, TLV272-Q1, TLV274-Q1 FAMILY OF 550- $\mu$ A/Ch 3-MHz RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

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## TYPICAL CHARACTERISTICS

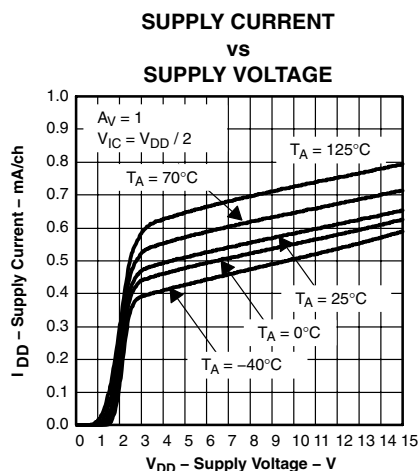


Figure 10

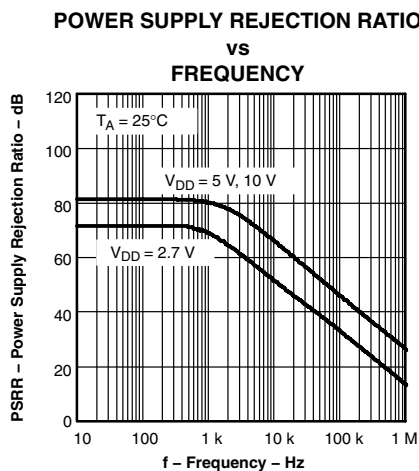


Figure 11

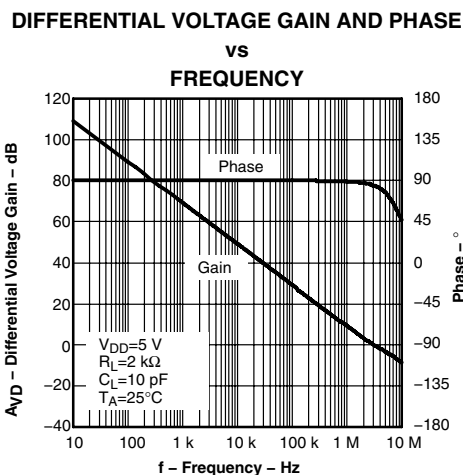


Figure 12

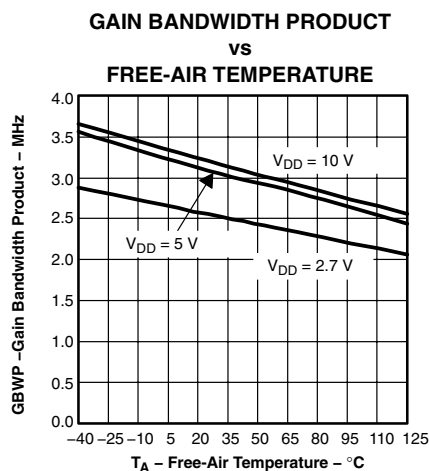


Figure 13

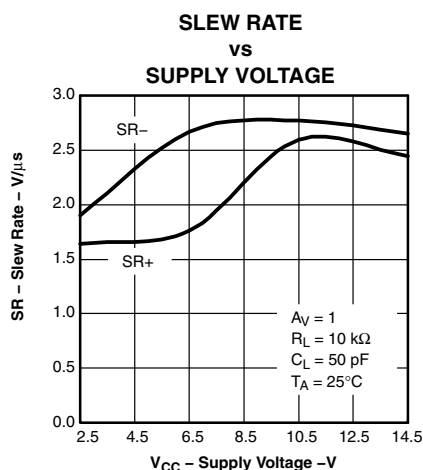


Figure 14

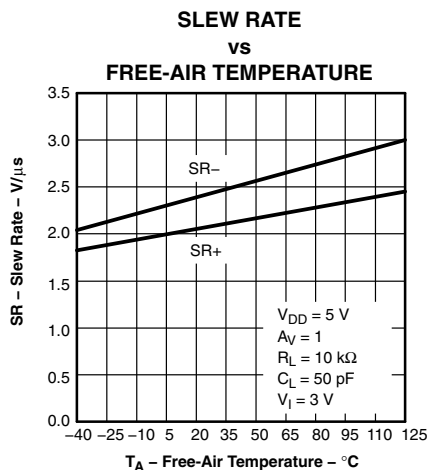


Figure 15

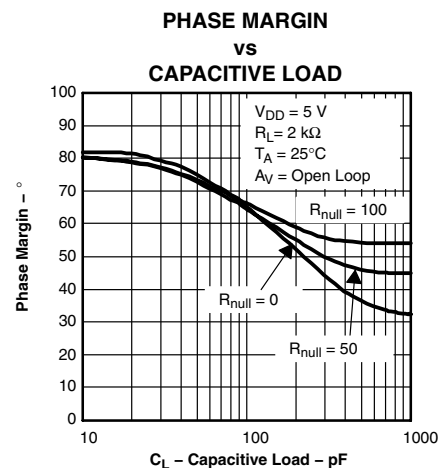


Figure 16



# TLV271-Q1, TLV272-Q1, TLV274-Q1

## FAMILY OF 550- $\mu$ A/Ch 3-MHz RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

SGLS275A – OCTOBER 2004 – REVISED JUNE 2008

### TYPICAL CHARACTERISTICS

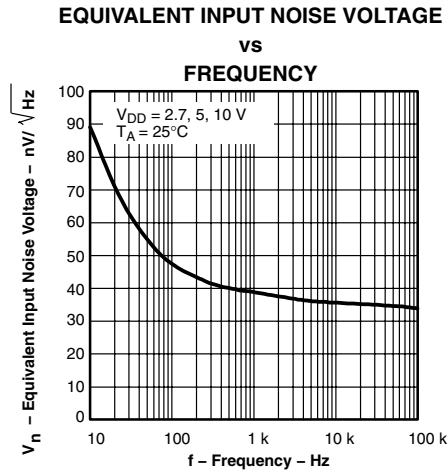


Figure 17

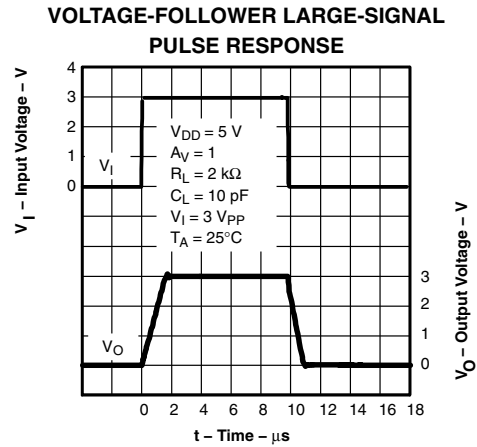


Figure 18

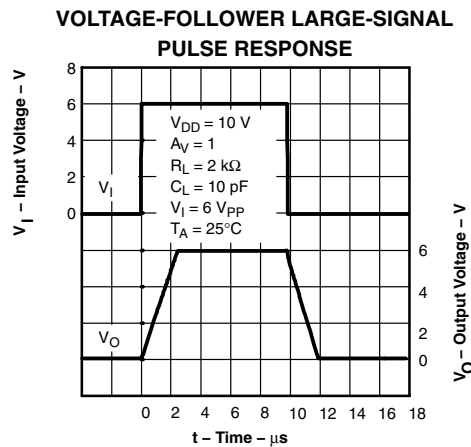


Figure 19

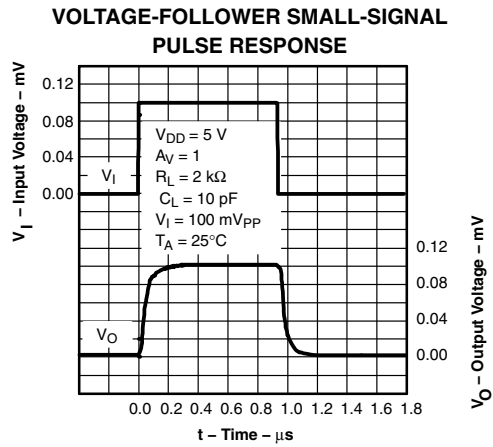


Figure 20

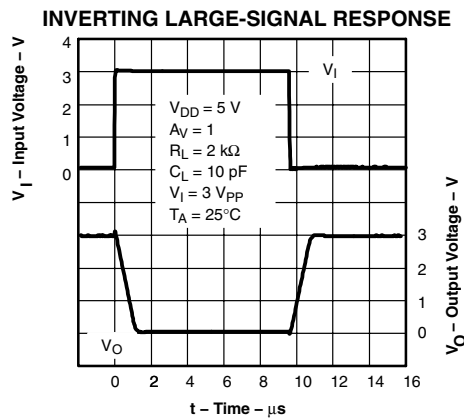


Figure 21

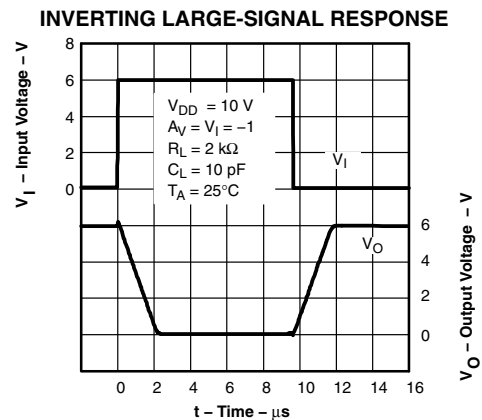


Figure 22

# TLV271-Q1, TLV272-Q1, TLV274-Q1

## FAMILY OF 550- $\mu$ A/Ch 3-MHz RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

SGLS275A – OCTOBER 2004 – REVISED JUNE 2008

### TYPICAL CHARACTERISTICS

INVERTING SMALL-SIGNAL RESPONSE

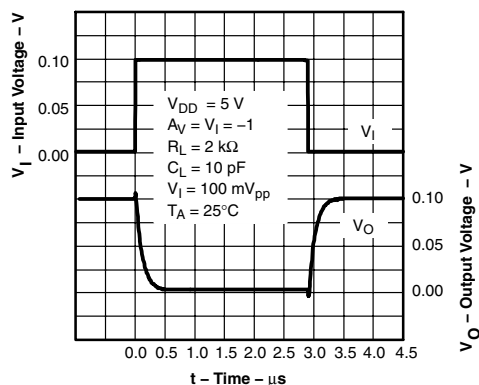


Figure 23

CROSSTALK  
vs  
FREQUENCY

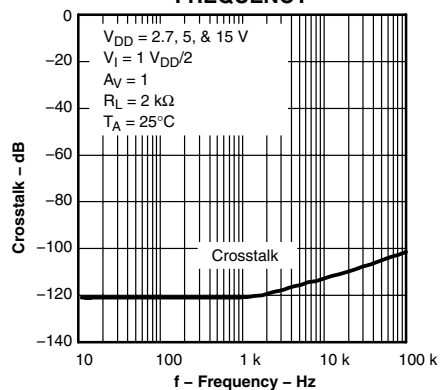


Figure 24

### APPLICATION INFORMATION

#### driving a capacitive load

When the amplifier is configured in this manner, capacitive loading directly on the output decreases the device's phase margin leading to high frequency ringing or oscillations. Therefore, for capacitive loads of greater than 10 pF, it is recommended that a resistor be placed in series ( $R_{NULL}$ ) with the output of the amplifier, as shown in Figure 25. A minimum value of 20  $\Omega$  should work well for most applications.

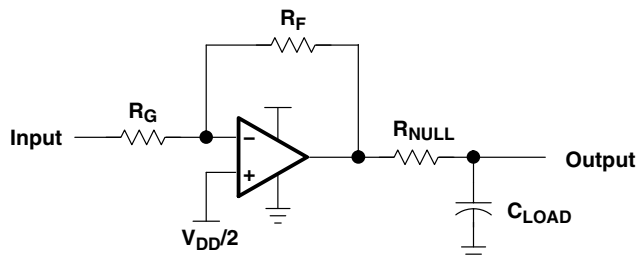


Figure 25. Driving a Capacitive Load

## APPLICATION INFORMATION

### offset voltage

The output offset voltage ( $V_{OO}$ ) is the sum of the input offset voltage ( $V_{IO}$ ) and both input bias currents ( $I_{IB}$ ) times the corresponding gains. The following schematic and formula can be used to calculate the output offset voltage:

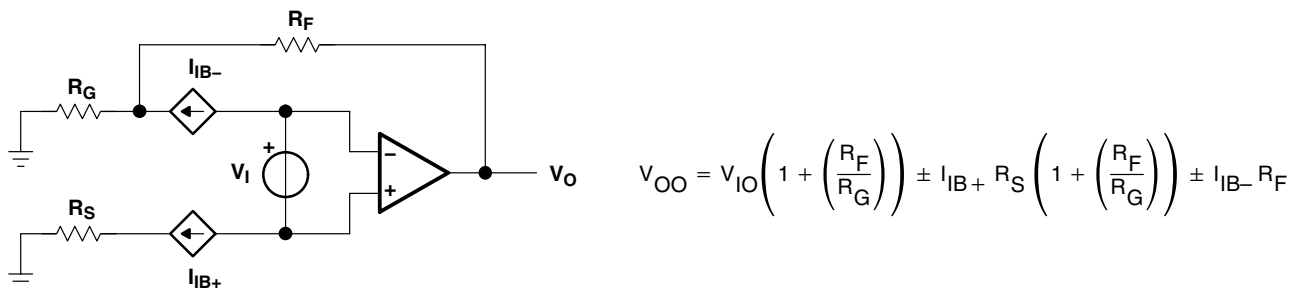


Figure 26. Output Offset Voltage Model

### general configurations

When receiving low-level signals, limiting the bandwidth of the incoming signals into the system is often required. The simplest way to accomplish this is to place an RC filter at the noninverting terminal of the amplifier (see Figure 27).

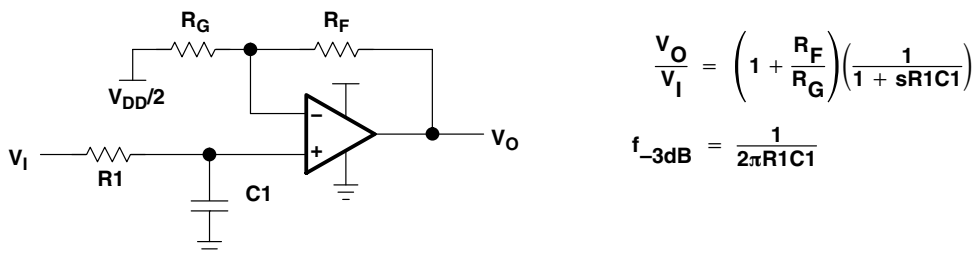


Figure 27. Single-Pole Low-Pass Filter

If even more attenuation is needed, a multiple pole filter is required. The Sallen-Key filter can be used for this task. For the best results, the amplifier should have a bandwidth that is 8 to 10 times the filter frequency bandwidth. Failure to do this can result in phase shift of the amplifier.

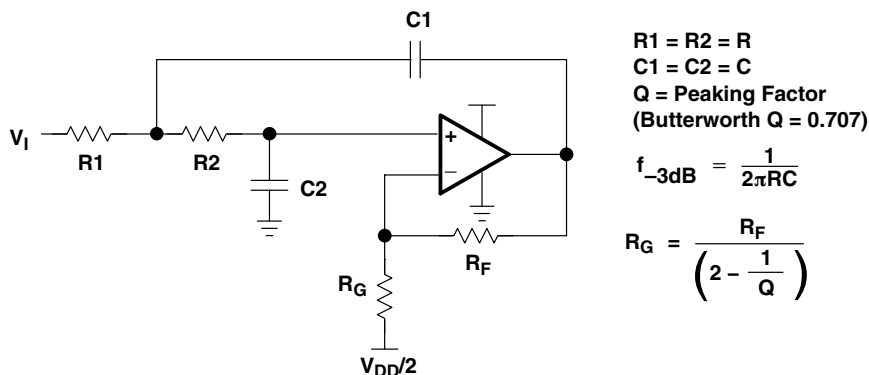


Figure 28. 2-Pole Low-Pass Sallen-Key Filter

# TLV271-Q1, TLV272-Q1, TLV274-Q1

## FAMILY OF 550- $\mu$ A/Ch 3-MHz RAIL-TO-RAIL OUTPUT

### OPERATIONAL AMPLIFIERS

SGLS275A – OCTOBER 2004 – REVISED JUNE 2008

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## APPLICATION INFORMATION

### circuit layout considerations

To achieve the levels of high performance of the TLV27x, follow proper printed-circuit board design techniques. A general set of guidelines is given in the following.

- **Ground planes**—It is highly recommended that a ground plane be used on the board to provide all components with a low inductive ground connection. However, in the areas of the amplifier inputs and output, the ground plane can be removed to minimize the stray capacitance.
- **Proper power supply decoupling**—Use a 6.8- $\mu$ F tantalum capacitor in parallel with a 0.1- $\mu$ F ceramic capacitor on each supply terminal. It may be possible to share the tantalum among several amplifiers depending on the application, but a 0.1- $\mu$ F ceramic capacitor should always be used on the supply terminal of every amplifier. In addition, the 0.1- $\mu$ F capacitor should be placed as close as possible to the supply terminal. As this distance increases, the inductance in the connecting trace makes the capacitor less effective. The designer should strive for distances of less than 0.1 inches between the device power terminals and the ceramic capacitors.
- **Sockets**—Sockets can be used but are not recommended. The additional lead inductance in the socket pins will often lead to stability problems. Surface-mount packages soldered directly to the printed-circuit board is the best implementation.
- **Short trace runs/compact part placements**—Optimum high performance is achieved when stray series inductance has been minimized. To realize this, the circuit layout should be made as compact as possible, thereby minimizing the length of all trace runs. Particular attention should be paid to the inverting input of the amplifier. Its length should be kept as short as possible. This helps to minimize stray capacitance at the input of the amplifier.
- **Surface-mount passive components**—Using surface-mount passive components is recommended for high performance amplifier circuits for several reasons. First, because of the extremely low lead inductance of surface-mount components, the problem with stray series inductance is greatly reduced. Second, the small size of surface-mount components naturally leads to a more compact layout thereby minimizing both stray inductance and capacitance. If leaded components are used, it is recommended that the lead lengths be kept as short as possible.



## APPLICATION INFORMATION

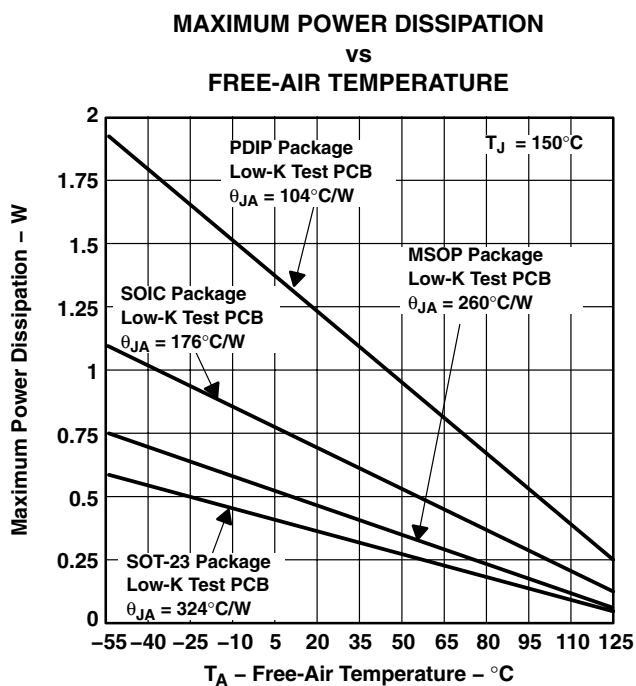
### general power dissipation considerations

For a given  $\theta_{JA}$ , the maximum power dissipation is shown in Figure 29 and is calculated by the following formula:

$$P_D = \left( \frac{T_{MAX} - T_A}{\theta_{JA}} \right)$$

Where:

- $P_D$  = Maximum power dissipation of TLV27x IC (watts)
- $T_{MAX}$  = Absolute maximum junction temperature (150°C)
- $T_A$  = Free-ambient air temperature (°C)
- $\theta_{JA} = \theta_{JC} + \theta_{CA}$
- $\theta_{JC}$  = Thermal coefficient from junction to case
- $\theta_{CA}$  = Thermal coefficient from case to ambient air (°C/W)



NOTE A: Results are with no air flow and using JEDEC Standard Low-K test PCB.

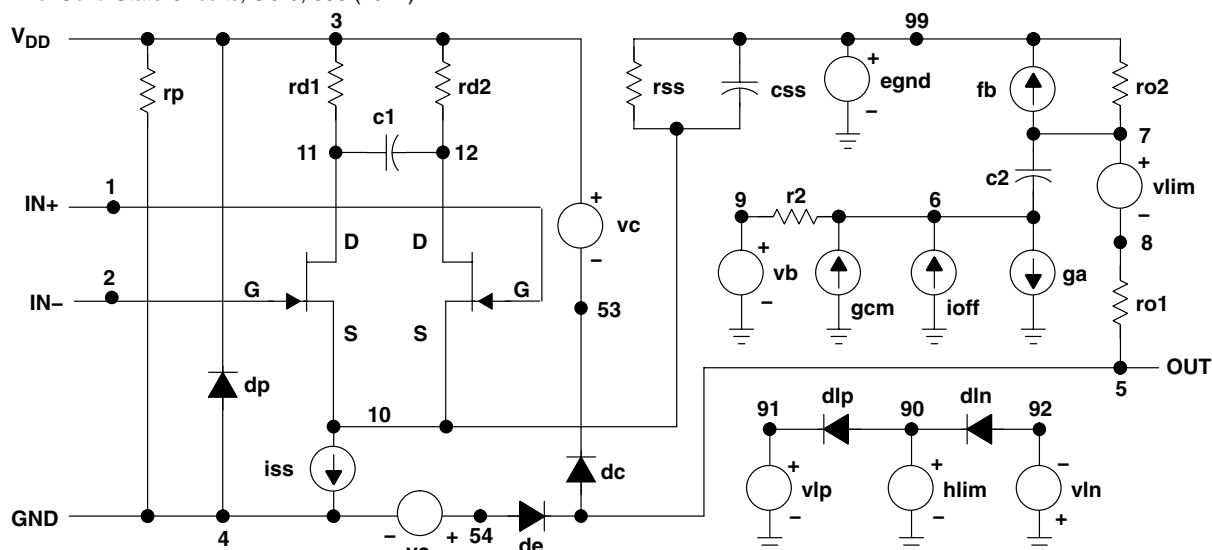
**Figure 29. Maximum Power Dissipation vs Free-Air Temperature**

## SGLS275A – OCTOBER 2004 – REVISED JUNE 2008

## macromodel information

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Unity-gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

NOTE 2: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers," *IEEE Journal of Solid-State Circuits*, SC-9, 353 (1974).



\*DEVICE=amp\_tlv27x\_highVdd,OP AMP,NJF,INT  
\* amp\_tlv\_27x\_highVdd operational amplifier "macromodel"  
\* subcircuit updated using Model Editor release 9.1 on 05/15/00  
\* at 14:40 Model Editor is an OrCAD product.

\* connections:

```

* connections:
*
* non-inverting input
* inverting input
* positive power supply
* negative power supply
* output
*

```

```
.subckt amp_tlv27x_highVdd
```

|      |    |    |               |
|------|----|----|---------------|
| c1   | 11 | 12 | 457.48E-15    |
| c2   | 6  | 7  | 5.0000E-12    |
| css  | 10 | 99 | 1.1431E-12    |
| dc   | 5  | 53 | dy            |
| de   | 54 | 5  | dy            |
| dlp  | 90 | 91 | dx            |
| dln  | 92 | 90 | dx            |
| dp   | 4  | 3  | dx            |
| egnd | 99 | 0  | poly(2) (3,0) |
| fb   | 7  | 99 | poly(5) vp va |

|        |     |                                          |                 |
|--------|-----|------------------------------------------|-----------------|
| ga     | 6   | 0                                        | 11 12 16.272E-6 |
| gcm    | 0   | 6                                        | 10 99 6.8698E-9 |
| iss    | 10  | 4                                        | dc 1.3371E-6    |
| hlim   | 90  | 0                                        | vlim 1K         |
| j1     | 11  | 2                                        | 10 jx1          |
| J2     | 12  | 1                                        | 10 jx2          |
| r2     | 6   | 9                                        | 100.00E3        |
| rd1    | 3   | 11                                       | 61.456E3        |
| rd2    | 3   | 12                                       | 61.456E3        |
| ro1    | 8   | 5                                        | 10              |
| ro2    | 7   | 99                                       | 10              |
| rp     | 3   | 4                                        | 150.51E3        |
| rss    | 10  | 99                                       | 149.58E6        |
| vb     | 9   | 0                                        | dc 0            |
| vc     | 3   | 53                                       | dc .78905       |
| ve     | 54  | 4                                        | dc .78905       |
| vlim   | 7   | 8                                        | dc 0            |
| vlp    | 91  | 0                                        | dc 14.200       |
| vln    | 0   | 92                                       | dc 14.200       |
| .model | dx  | D(Is=800.00E-18)                         |                 |
| .model | dy  | D(Is=800.00E-18 Rs=1m Cjo=10p)           |                 |
| .model | jx1 | NJF(Is=500.00E-15 Beta=198.03E-6 Vto=-1) |                 |
| .model | jx2 | NJF(Is=500.00E-15 Beta=198.03E-6 Vto=-1) |                 |
| .ends  |     |                                          |                 |

### Figure 30. Boyle Macromodel and Subcircuit

*P*Spice and *P*arts are trademarks of MicroSim Corporation.



## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| TLV271QDBVRQ1    | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM   | -40 to 125   | 271Q                    | <a href="#">Samples</a> |
| TLV271QDRG4Q1    | ACTIVE        | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM   | -40 to 125   | T271Q1                  | <a href="#">Samples</a> |
| TLV271QDRQ1      | ACTIVE        | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM   | -40 to 125   | T271Q1                  | <a href="#">Samples</a> |
| TLV272QDRG4Q1    | ACTIVE        | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM   | -40 to 125   | T272Q1                  | <a href="#">Samples</a> |
| TLV272QDRQ1      | ACTIVE        | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM   | -40 to 125   | T272Q1                  | <a href="#">Samples</a> |
| TLV274QDRG4Q1    | ACTIVE        | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM   | -40 to 125   | TLV274Q1                | <a href="#">Samples</a> |
| TLV274QDRQ1      | ACTIVE        | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM   | -40 to 125   | TLV274Q1                | <a href="#">Samples</a> |
| TLV274QPWRG4Q1   | ACTIVE        | TSSOP        | PW                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM   | -40 to 125   | TLV274Q                 | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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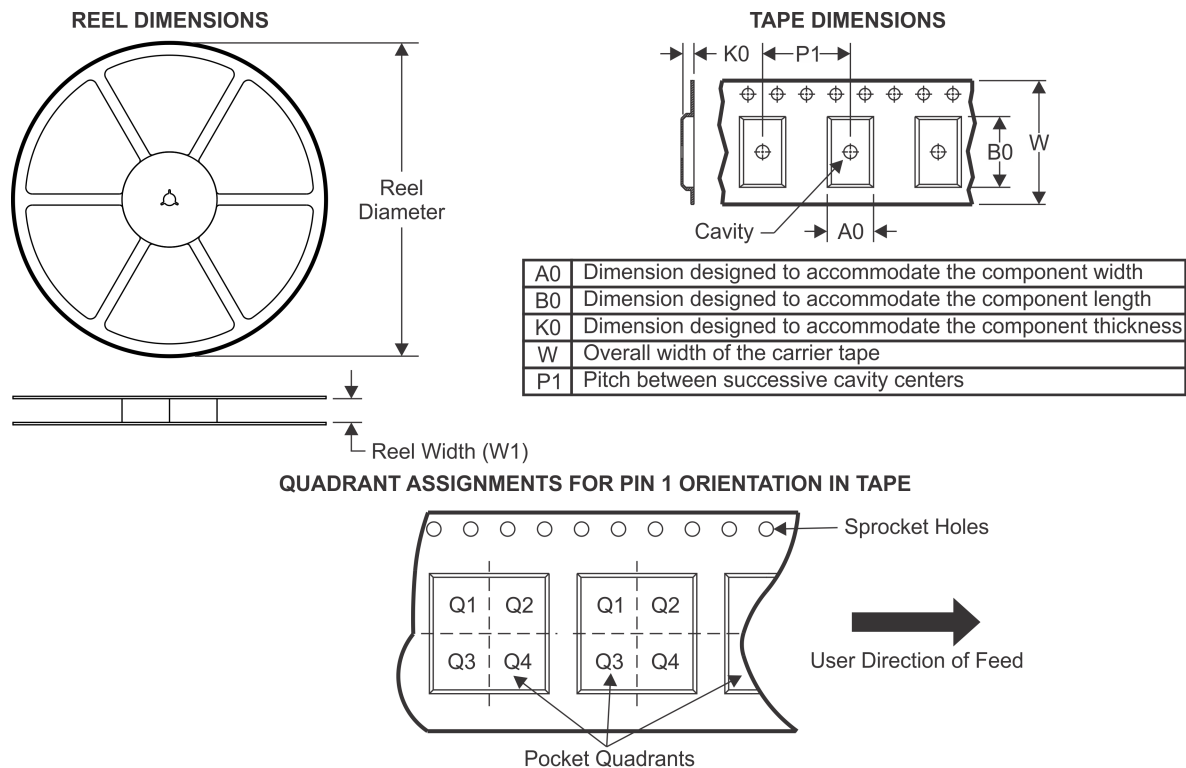
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF TLV271-Q1, TLV272-Q1, TLV274-Q1 :**

- Catalog: [TLV271](#), [TLV272](#), [TLV274](#)

NOTE: Qualified Version Definitions:

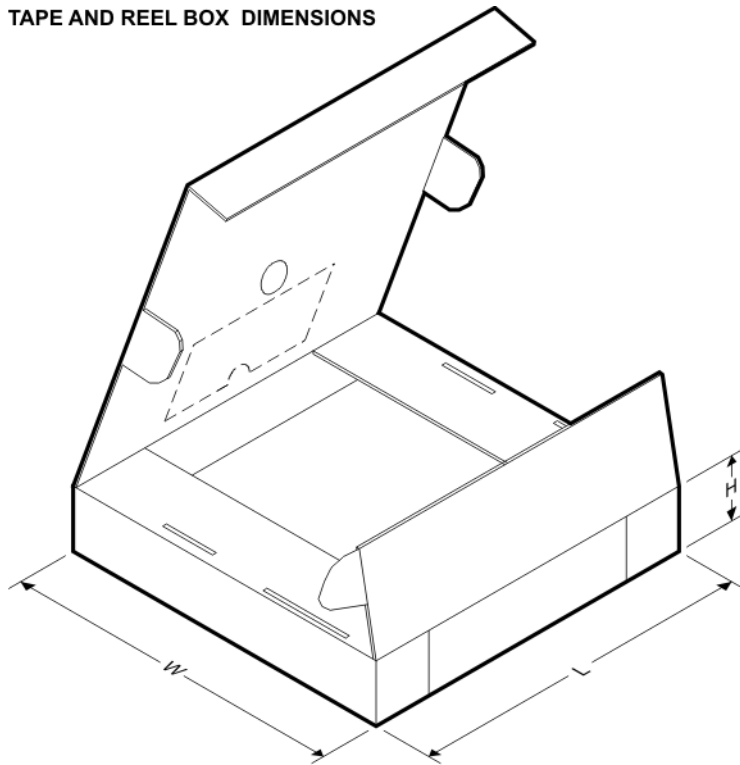
- Catalog - TI's standard catalog product

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TLV271QDBVRQ1  | SOT-23       | DBV             | 5    | 3000 | 180.0              | 9.0                | 3.15    | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TLV274QPWRG4Q1 | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLV271QDBVRQ1  | SOT-23       | DBV             | 5    | 3000 | 182.0       | 182.0      | 20.0        |
| TLV274QPWRG4Q1 | TSSOP        | PW              | 14   | 2000 | 367.0       | 367.0      | 35.0        |

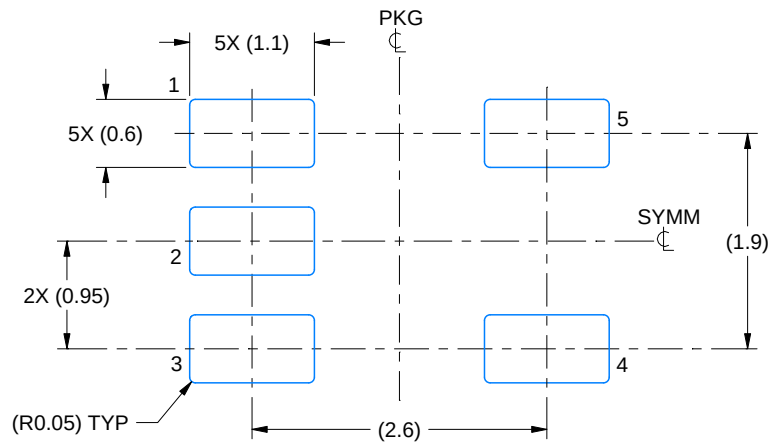


# EXAMPLE BOARD LAYOUT

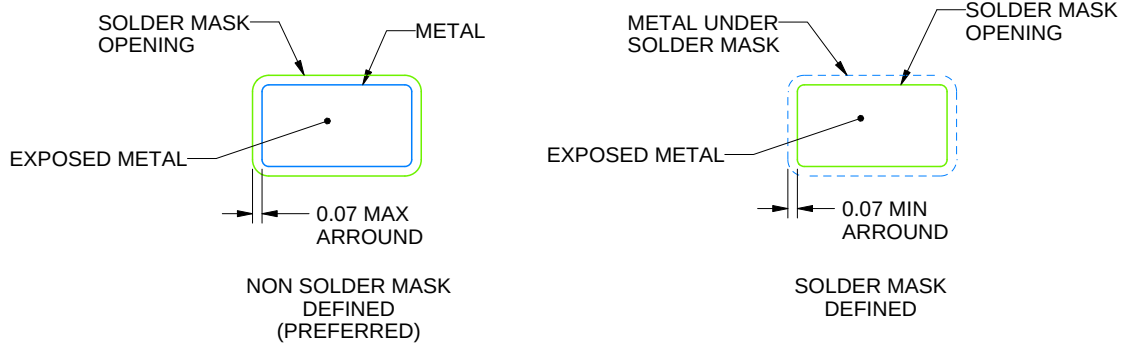
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4214839/E 09/2019

NOTES: (continued)

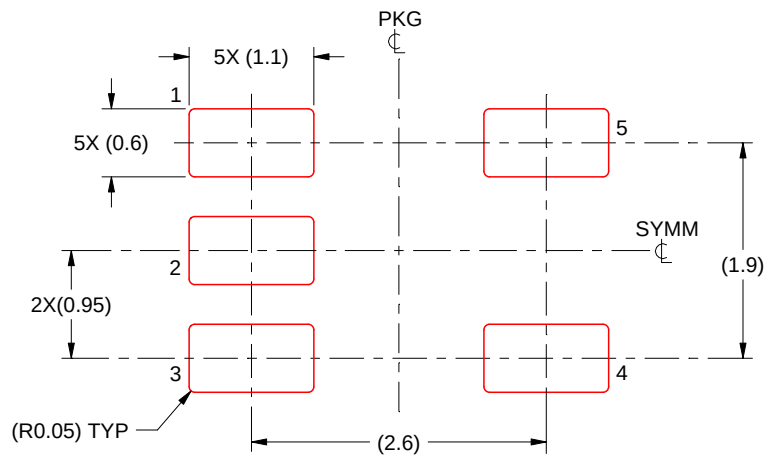
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

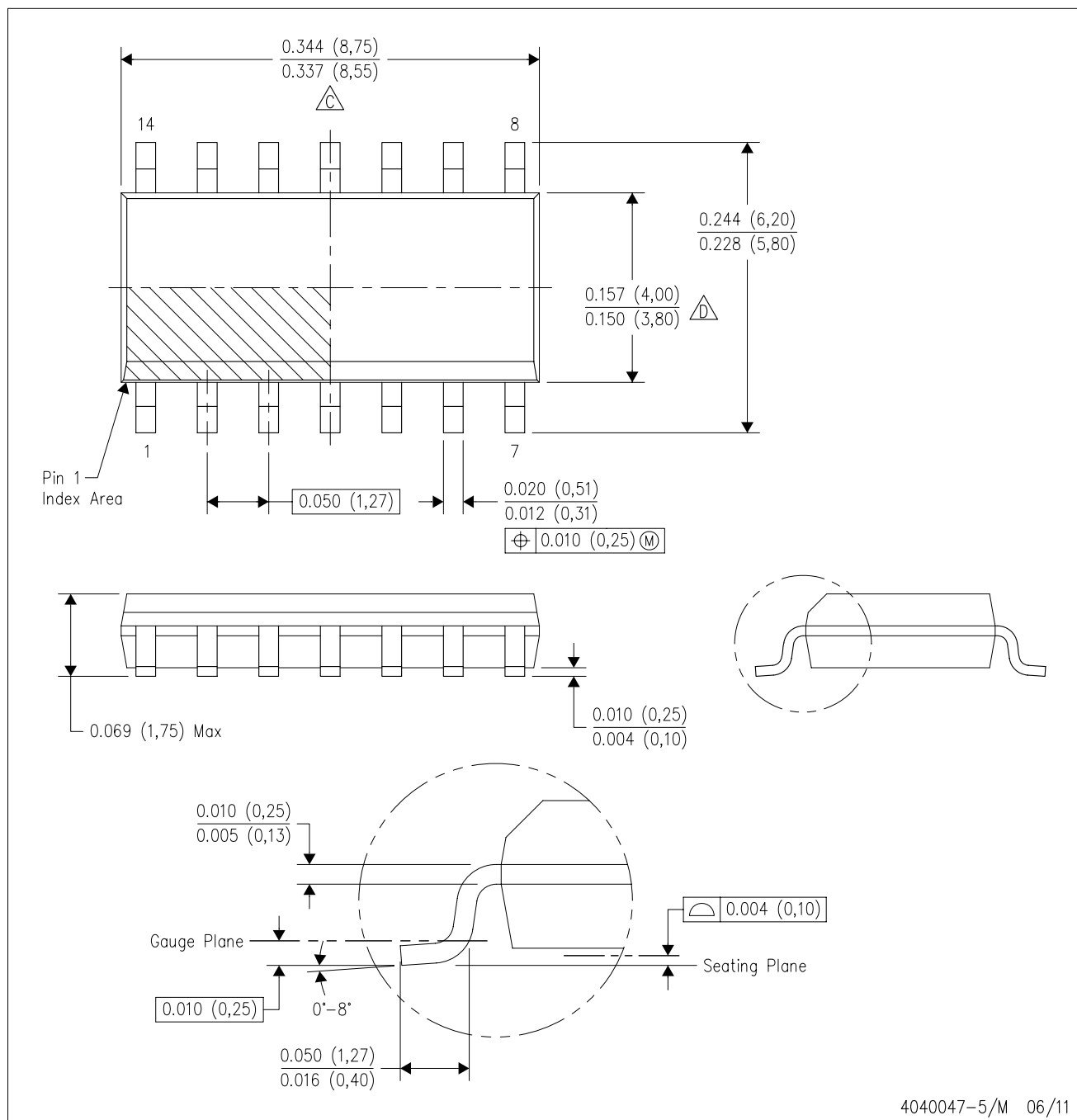
4214839/E 09/2019

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



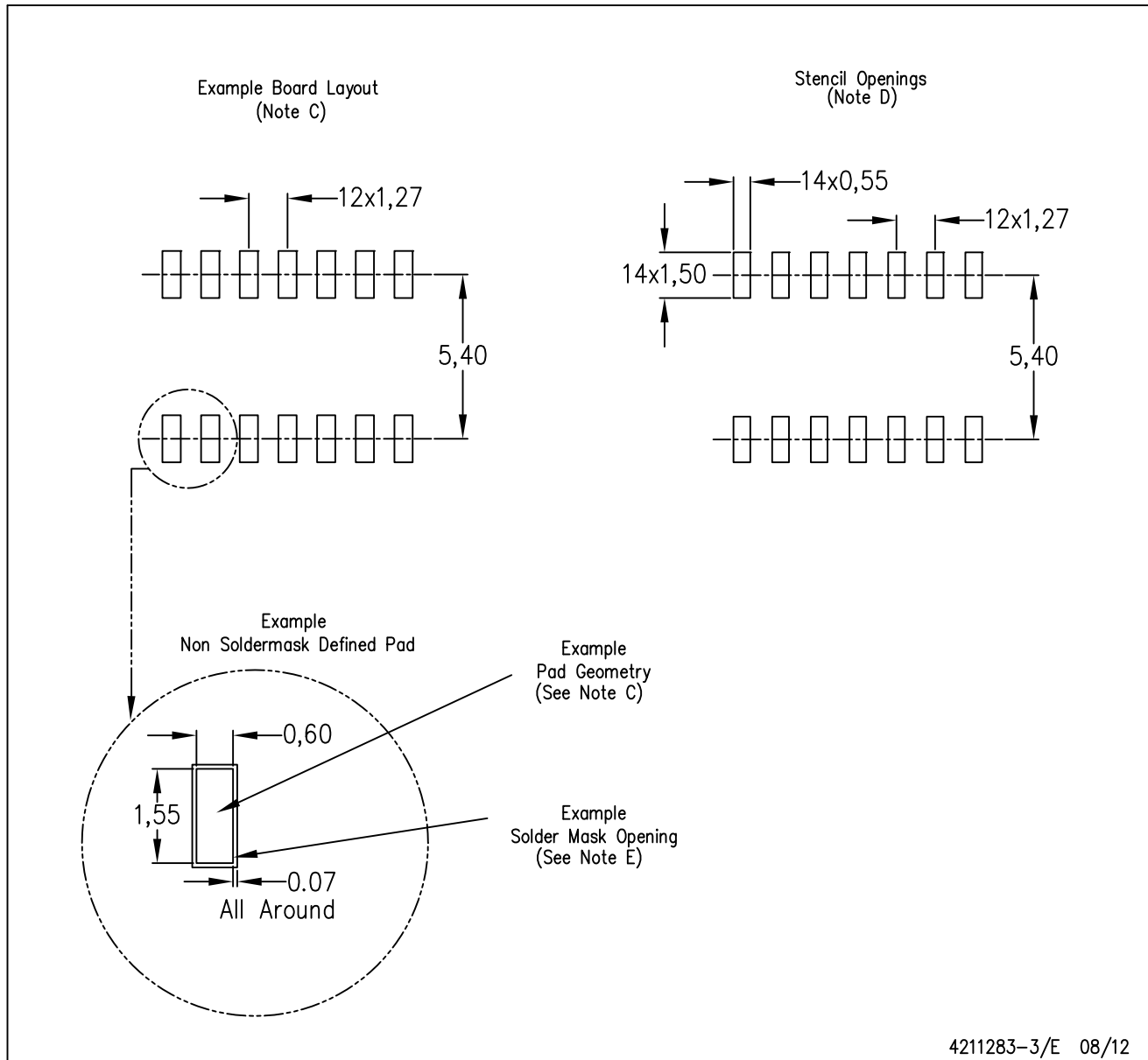
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



D (R-PDSO-G14)

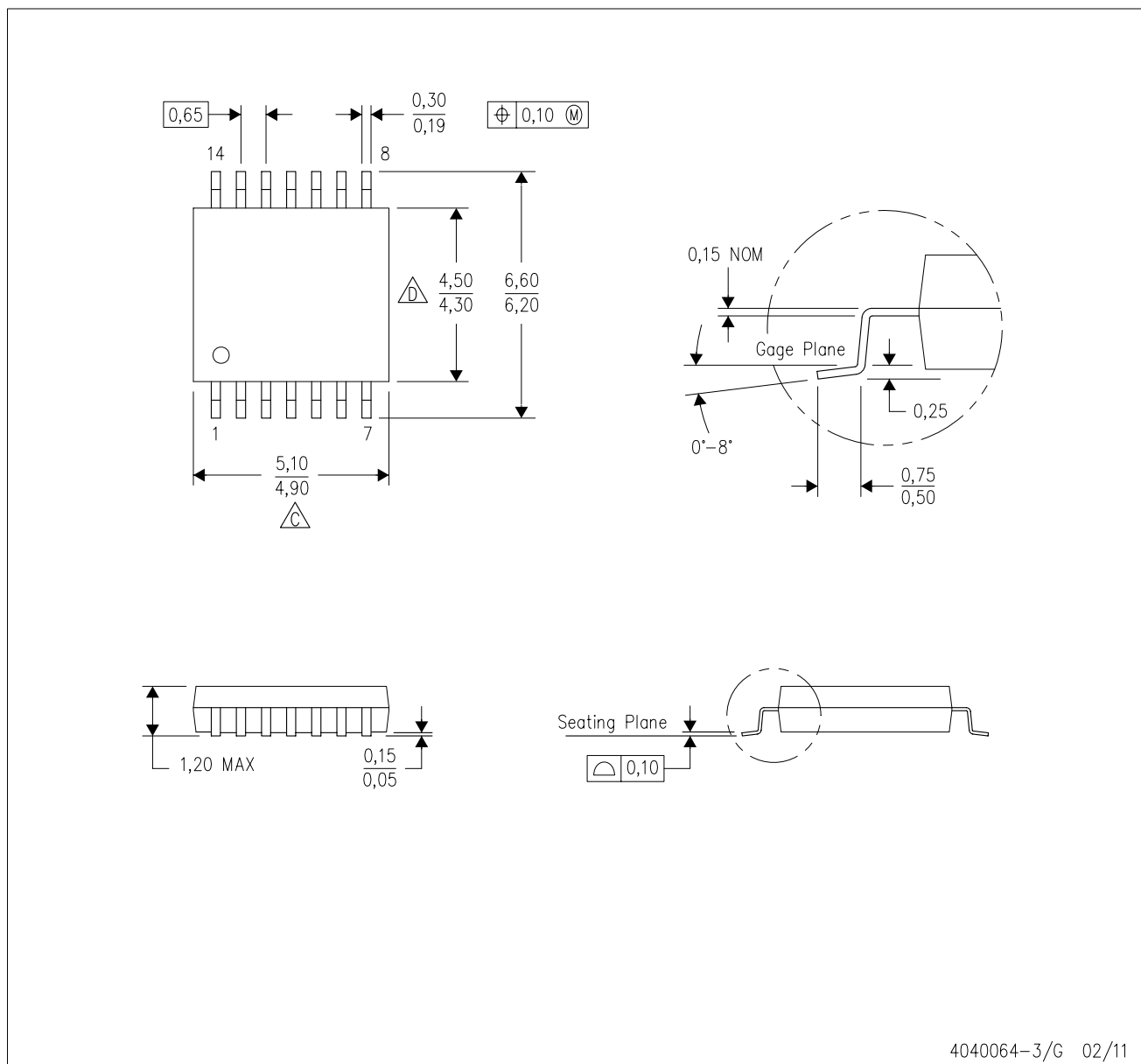
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE

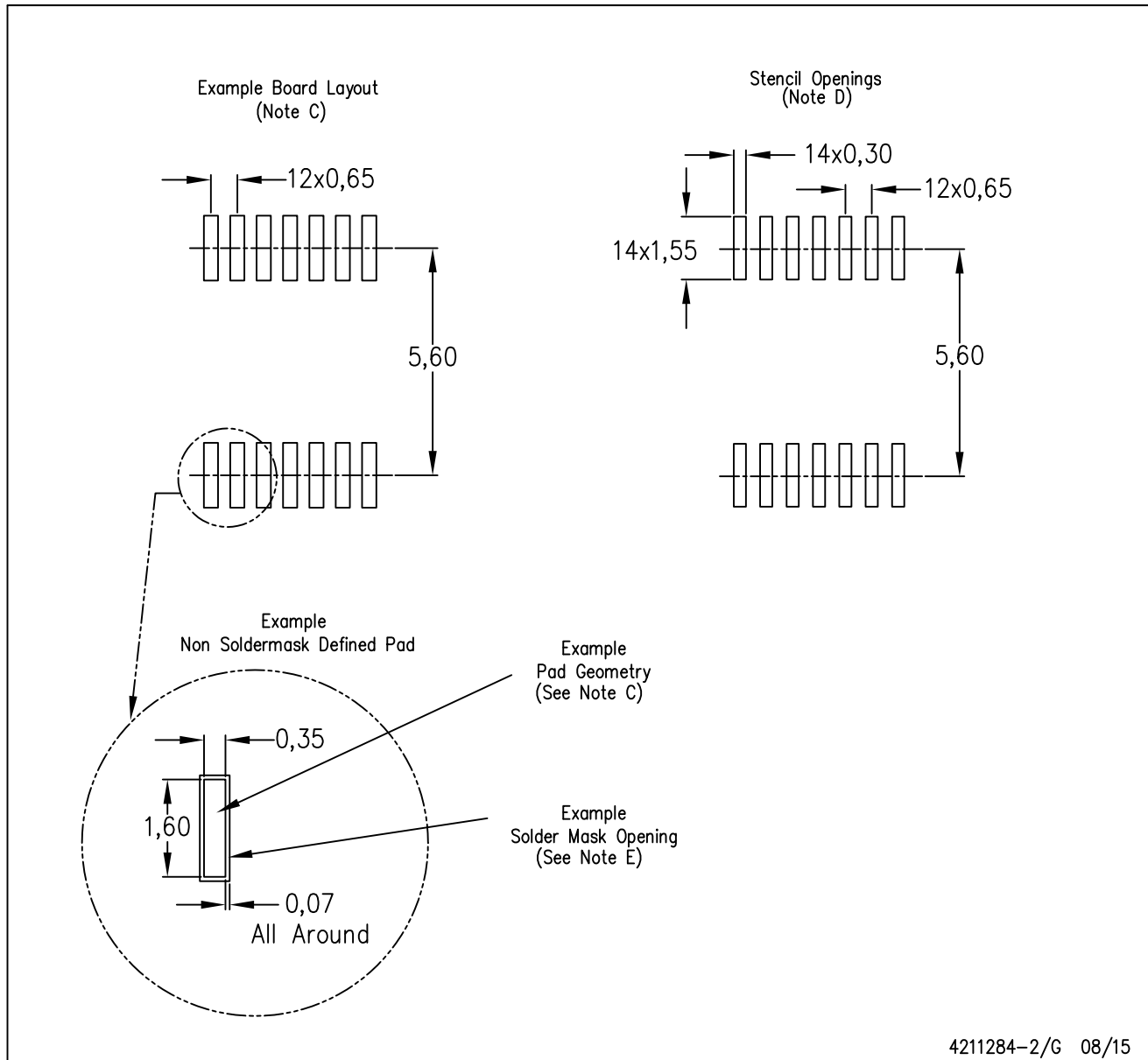


4040064-3/G 02/11

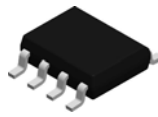
- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
  - E. Falls within JEDEC MO-153

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

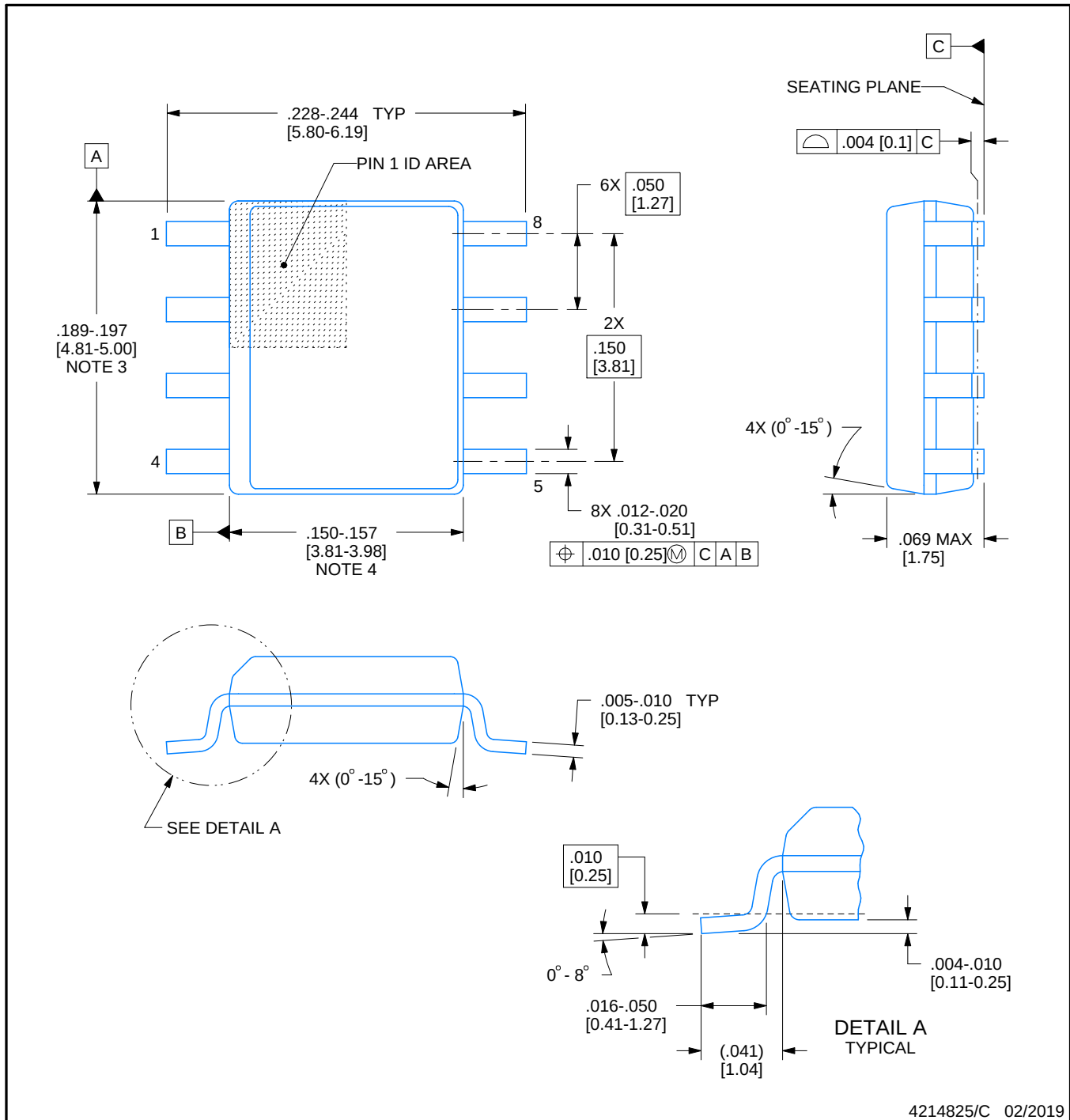


**D0008A**

# PACKAGE OUTLINE

**SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

## NOTES:

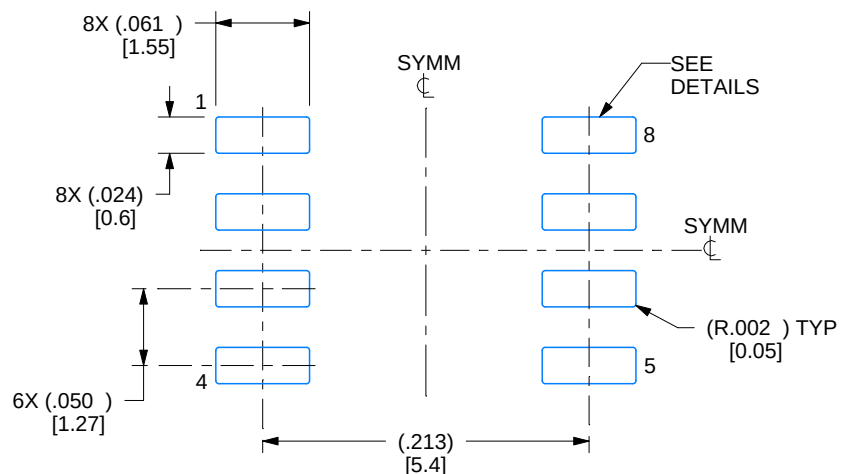
1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

# EXAMPLE BOARD LAYOUT

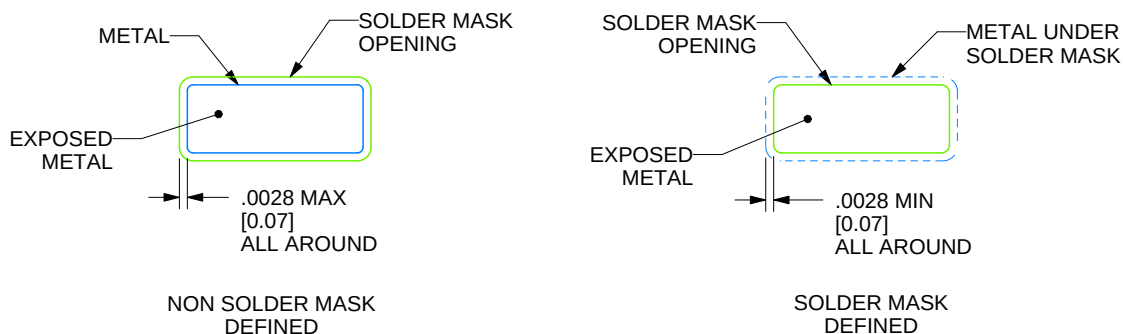
D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

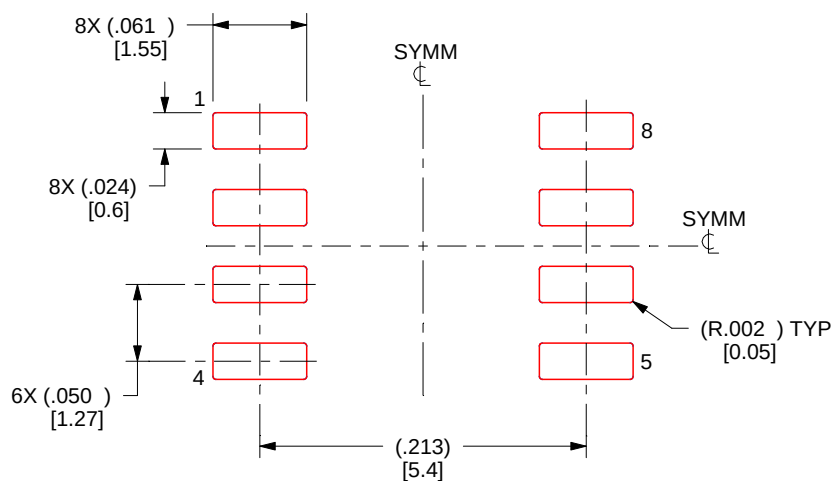
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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